

# Use of Copper Microparticles in SEBS/PP Compounds. Part 1: Effects on Morphology, Thermal, Physical, Mechanical and Antibacterial Properties

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Received: April 25, 2018; Revised: November 30, 2018; Accepted: January 17, 2019

An alternative for producing thermoplastic elastomers (TPEs) with antibacterial properties is to add copper to the polymeric matrices. This study investigates the effects of the addition of copper microparticles on the morphological, thermal, physical and mechanical behavior and antibacterial properties of a blend composed by styrene-(ethylene-butylene)-styrene triblock copolymer (SEBS) and polypropylene (PP) homopolymer. The copper microparticles used (commercial grade, produced by electrolytical process) were dispersed in a TPE matrix composed by SEBS/PP. Two bacterial species associated with infections (*Escherichia coli* and *Staphylococcus aureus*) were used in the antibacterial assays. The incorporation of copper microparticles in TPE matrix did not promote expressive changes in the thermal, physical and mechanical properties of the compounds. The findings from antibacterial assays showed a reduction of 99.99% in bacterial counts.

**Keywords:** SEBS, thermoplastic elastomers, copper microparticles, antibacterial.

## 1. Introduction

Compounds based on blends of styrene-(ethylene-butylene)-styrene (SEBS) and polypropylene (PP) represent an important type of thermoplastic elastomer (TPE) with applications in a range of rubber items, such as soft-touch surface on personal care products, tools, toys, housewares, automotive materials, among others. This kind of TPE replaces vulcanized rubber and polyvinyl chloride with the advantage of being fully recyclable, thus promoting less impact on the environment. In a typical production of SEBS/PP blends, the SEBS is mixed with PP to make stiffer materials and facilitate its processability<sup>1</sup>. Also, ingredients such as plasticizing oil, other polymers, fillers, and additives may be present in the compound formulation.

In various applications, the antimicrobial characteristic is desirable to avoid staining, bad smell, and deterioration. Infections caused by pathogenic microorganisms are a major concern and the use of polymers with antimicrobial properties gains an increasing interest from academic and industrial point of view<sup>2</sup>. Moreover, antimicrobial polymers are used as a strategy to prevent hospital-acquired infections<sup>3,4</sup>. Several publications report studies about the use of polymer/copper formulations in antimicrobial applications<sup>3,5-12</sup>. However, except for previous work published by our research group

on the use of copper nanoparticles<sup>13</sup>, publications based on SEBS/PP blends were not found in the literature. Compounds based on SEBS/PP do not have inherent biocidal properties. The usual form to obtain this characteristic is by adding an antimicrobial agent to polymers in the molten state. According to Jones<sup>14</sup>, antimicrobial polymers fit into two categories: organic (with biostatic properties) and inorganic (that combine biocidal and biostatic properties). Inorganic antimicrobials substances present metal ions as their active agent. They are stable in the processing conditions of thermoplastic polymers (~200°C) and, once incorporated in the compound, are continuously available during the life time of the particular finished product<sup>14,15</sup>. The metals commonly applied as biocides in polymers are silver, copper, and zinc<sup>3</sup>.

It is noteworthy the efficiency of copper against pathogenic bacteria, fungi, algae, and viruses. Previous studies with Gram-positive and Gram-negative have shown that the toxic mechanisms of copper rely on bacterial membrane damage, accumulation of copper ions in the cell<sup>16</sup>, and denaturation of nucleic acids<sup>17</sup>, which are also related to the broad-spectrum of actions including multidrug-resistant organisms<sup>18</sup>

Among the various methods of copper preparation, the powder produced from copper sulfate using electrolytic cells stands out as the main process. This method allows the obtainment of copper microparticles with high purity, besides specific size and shape (dendrites with a high surface area).

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The main industrial applications of electrolytic copper are electrical components, friction materials and sintering of parts.

This study investigates the effects of copper microparticles produced by an electrolytic process on the morphological, thermal, physical and mechanical behavior, besides the antibacterial properties of SEBS/PP compounds.

## 2. Experimental

### 2.1 Materials

The styrene-(ethylene-butylene)-styrene triblock copolymer (SEBS) was supplied by Kraton Polymers (styrene/rubber ratio of 30/70, molecular weight of 192.031 g.mol<sup>-1</sup> and Mw/Mn= 1.36) and polypropylene homopolymer was supplied by Braskem (melt flow index of 1.5 g/10 min). The oil plasticizer used was a white mineral oil with a viscosity of 105 cSt (Raj Petro). Calcium carbonate with 325 mesh was used as mineral filler (Mocal). The commercial grade of copper microparticles with a density of 1.18 g/cm<sup>3</sup> and an average particle size of 46 μm as average particle size (provided by Brutt Indústria Metalúrgica) was used as antibacterial agent.

### 2.2 Preparation of the compounds

All the compounds based in SEBS/PP/oil/calcite have a basic formulation, named 0% CuMP, as show in Table 1. Copper microparticles weight percentages were used on the basic formulations in 1 %, 2 % and 4 % and this was the only variable in the compounds with copper, named 1% CuMP, 2% CuMP and 4% CuMP.

The materials were fabricated in a co-rotating double screw extruder (AX Plásticos, L/D ratio of 40 and 16 mm screw diameter) with a temperature profile from 150°C to 190°C. The extrusion parameters were kept constant for all samples. TPE specimens were cut from a flat sheet (130 mm x 130 mm x 2 mm) prepared in an injection molding machine (Haitian, PL860) at 190°C. After preparation, the specimens were conditioned at 23 ± 2°C and 50 ± 5% relative humidity for 72h before testing.

## 3. Methods

### 3.1 Thermal properties

Differential Scanning Calorimetry (DSC) and Thermogravimetric (TGA) analysis were used to evaluate the thermal properties of the compounds. TGA analysis was

performed in a TA Q500 (TA Instruments) under nitrogen flow from 20°C to 800°C (heating rate of 20°C/min) and sample weight of ~ 11 mg. For DSC assay the samples were heated from -30°C to 180°C at a heating rate of 10°C/min in a DSC Q100 (TA Instruments) under nitrogen flow. Data were collected in the second heating to avoid interference of the thermal history of the compounds. The degree of crystallinity of the PP phase of the compounds,  $X_{PP}$ , was calculated by applying equation (1)<sup>1</sup>:

$$X_{PP} (\%) = \frac{\Delta H_{TPE}}{m_{PP} \times \Delta H_{PP}} \times 100 \quad (1)$$

Where  $\Delta H_{TPE}$  is the heat of crystallization of the PP phase,  $m_{PP}$  is the PP mass fraction in the compound and  $\Delta H_{PP}$  is the heat of crystallization per gram of 100% crystalline PP (209 J/g).

### 3.2 Morphology

Scanning Electron Microscopy (SEM) was performed to evaluate the morphology of TPE blends and copper microparticles. The TPE samples were torn at ambient temperature, placed in carbon tape, metalized with gold and analyzed with a SEM of field emission (SEM-FEG) (Auriga, Zeiss). Images were acquired with 30 kV and working distance (WD) of 5.5 mm. The copper microparticles images were analyzed in an equipment Inspect F50 (FEI), with 20 kV and working distance (WD) of 11.9 mm. Circular specimens of 25 mm in diameter and 2 mm thickness (cut from molten plates) were immersed for 72 hours in toluene to calculate the grade of co-continuity of the SEBS in the compounds, as proposed by Sengupta and Noordermeer.<sup>19</sup>

### 3.3 Physical and mechanical properties

The density was measured in accordance with ASTM D 792. Tensile properties were analyzed according to ASTM D 412C, using an Emic DL 2000 universal test machine. The determination of the hardness Shore A of the compounds was performed according to ASTM D 2240, using a Durometer Bareiss HPE-A, with a reading time of 3 seconds and resolution of 0.1 Shore A. At least five test specimens were tested to determine the result of each physical-mechanical test.

### 3.4 Antibacterial activity

The antibacterial efficiency of the loaded and non-loaded compounds were evaluated according to the Japan Industrial Standard (JIS) Z 2801: 2010. In this analysis, specimens of TPE blends (50 mm x 50 mm) were placed in a sterile Petri dish and 400 μL of an solution with 2.5 x 10<sup>5</sup> CFU/mL of *Escherichia coli* ATCC 8739 (*E. coli*) or 2,7 x 10<sup>5</sup> CFU/mL of *Staphylococcus aureus* ATCC 6538 (*S. aureus*) suspension were inoculated on the specimen surface. All of them were incubated for 24 h at 35 ± 1°C. The difference between the number of colonies forming units (CFUs) at zero hour and

**Table 1.** Components of basic formulation of compounds (0% CuMP).

Ingredient	SEBS	PP	Oil	Calcite
phr	100	44	136	89

Note: phr (part per hundred of resin)

after 24 hours of incubation was used to measure antibacterial activity (in percentage).

## 4. Results and Discussion

### 4.1 Thermal properties

The Figures 1 and 2 show, respectively, the TGA (thermogravimetric) and the DTG (derivative thermogravimetric) curves of individual components (SEBS, PP and oil plasticizer) and the compounds. As shown in Figure 1, the oil is the least thermally stable component, with a maximum rate of degradation at 369°C, followed by SEBS (448°C) and by PP (469°C).

As can be seen in Figure 2, the addition of CuMP did not promote expressive changes in the thermal degradation behavior of the compounds. In all samples three decomposition peaks were observed, the first and the second are related to the decomposition of oil and the third is related to the SEBS and PP. The higher thermal stability of the oil plasticizer when aggregated into the compound and its two-step decomposition can be attributed to the interaction with the other components of the formulation.

The presence of copper microparticles promoted a slight increase in thermal stability in the initial stage of degradation. This can be observed in the increase in temperature of the loss of 3% of mass ( $T_{3\%}$ ) shown in Table 2. However, with the progress of the decomposition reaction kinetics, the behavior

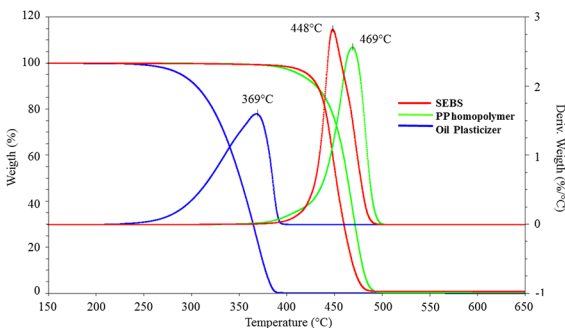


Figure 1. TGA and DTG curves of the individual components.

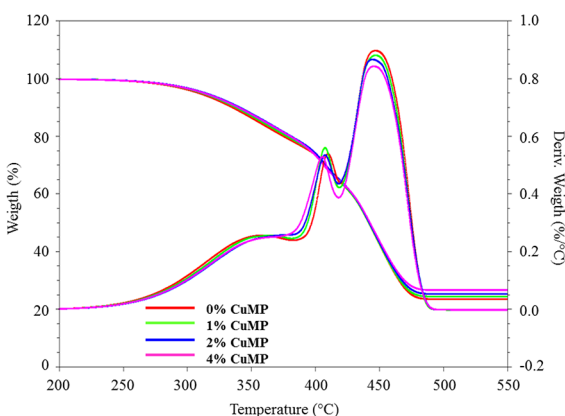


Figure 2. TGA and DTG curves of the compounds.

tends to be similar in all compositions without significant variations in the final temperatures of each decomposition step. The action of the metal particles in polymers is dependent on the thermal conductivity of the particles, particle morphology, volume fraction, and dispersion in the polymer matrix<sup>20</sup>. Gorghiu et al<sup>21</sup>. investigated the effects of metals on thermal degradation of polyethylenes, and observed that, among the metals evaluated, copper was the most reactive, causing degradation with the shortest oxidation induction time and the highest oxidation rate. Based on various studies, copper presents high heat capacity and thermal conductivity and can encourage or retard, at different degrees, the thermal degradation of the organic phase<sup>8,21,22,23</sup>.

The thermal properties obtained via DSC are presented in Table 3. The crystallization temperature ( $T_c$ ) of PP phase reduced slightly with the increase in the copper content. This indicates that microparticles affect the crystallization process of the PP homopolymer. An effect that is corroborated by the lower degree of crystallinity ( $X_{pp}$ ) in the samples with CuMP.

In the compounds with CuMP, fusion enthalpy ( $\Delta H_f$ ) of the PP phases decreases very little, from 11.7 J/g (0% of CuMP) to 10.8 J/g (4% of CuMP). No significant change was observed in the melting temperature of the PP phase. Through DSC it was not possible to detect the glass transition of PP phase in the compounds. This was already expected and can be explained by the fact that in ternary blends with SEBS the  $T_g$  of the PP-oil phase is a function of the total oil content. The literature has reported that the high temperature of transition of the PP rich phase disappears above 30 wt % oil<sup>1</sup>.

Figure 3 shows the cooling curves of the compounds and the pure SEBS obtained by DSC. As seen, the cooling curves of the compounds show a small exothermic peak close to -5°C and in pure SEBS this peak occurs at around 5°C. The nature of these peaks is attributed to the crystallization of the ethylene blocks contained in the EB (ethylene butylene) phase of SEBS<sup>24</sup>. In the compounds, the oil is present in the olefinic EB blocks and it plasticizes this EB phase<sup>1</sup> which explains the decrease in crystallization temperature compared to pure SEBS. An exothermic crystallization peak from the PP phase was observed in the compounds near to 107°C. The temperature of crystallization of PP in the compounds was also lower than that observed in PP pure (see Table 2) which can be explained by the diluent character of the other components in the system, which delay the crystallization process of PP as reported in a previous study<sup>25</sup>.

### 4.2 Morphology

As can be seen in Figure 4, the CuMP used in this study presents a dendritic morphology. A dendrite is a hyper branched architecture formed by individual copper grains that are organized in a main stem and several lateral branches.

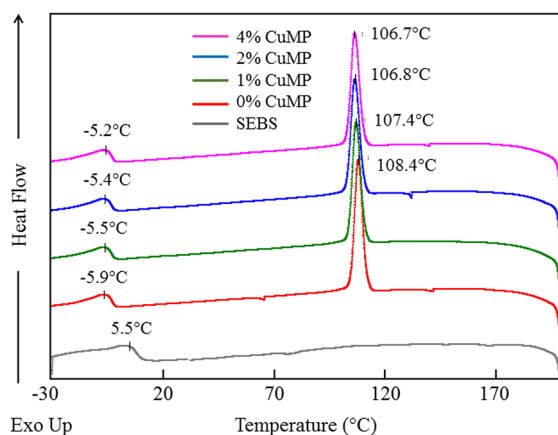
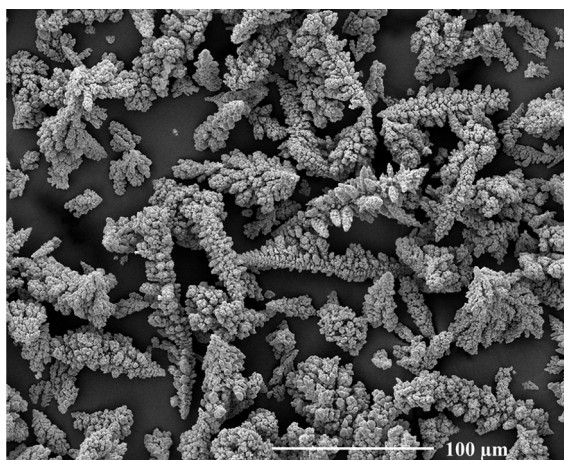
Through SEM images, it was possible to evaluate the dispersion of the CuMP in the compounds. Figures 5a, 5b and

**Table 2.** TGA and DTG data of TPE compounds

Sample	TGA				DTG		
	T <sub>3%</sub> (°C)	T <sub>end 1<sup>st</sup> Step</sub> (°C)	T <sub>end 2<sup>nd</sup> Step</sub> (°C)	T <sub>3<sup>rd</sup> Step</sub> (°C)	TP1 (°C)	TP2 (°C)	TP3 (°C)
0% CuMP	294.8	382.5	419.8	472.8	357.4	409.9	447.0
1% CuMP	297.1	381.5	418.8	473.0	364.3	407.6	446.9
2% CuMP	299.0	380.8	417.8	473.3	375.4	407.7	444.6
4% CuMP	298.0	382.5	417.8	473.2	367.3	405.4	445.7

**Table 3.** Melting (T<sub>m</sub>) and Crystallization (T<sub>c</sub>) Temperatures, Fusion, and Crystallization Enthalpy (ΔH<sub>f</sub>) and degree of crystallinity of PP phase (X<sub>PP phase</sub>) obtained by DSC.

Sample	T <sub>m</sub> (°C)	ΔH <sub>f PP phase</sub> (J/g)	T <sub>c PP phase</sub> (°C)	ΔH <sub>c PP phase</sub> (J/g)	X <sub>PP phase</sub> (%)
0% CuMP	152.6	11.7	108.4	13.2	47.2
1% CuMP	152.2	11.4	107.4	12.6	46.2
2% CuMP	152.4	10.9	106.8	12.4	44.5
4% CuMP	152.2	10.8	106.7	12.1	45.3
Pure PP	166.8	88.8	113.4	90.6	42.5

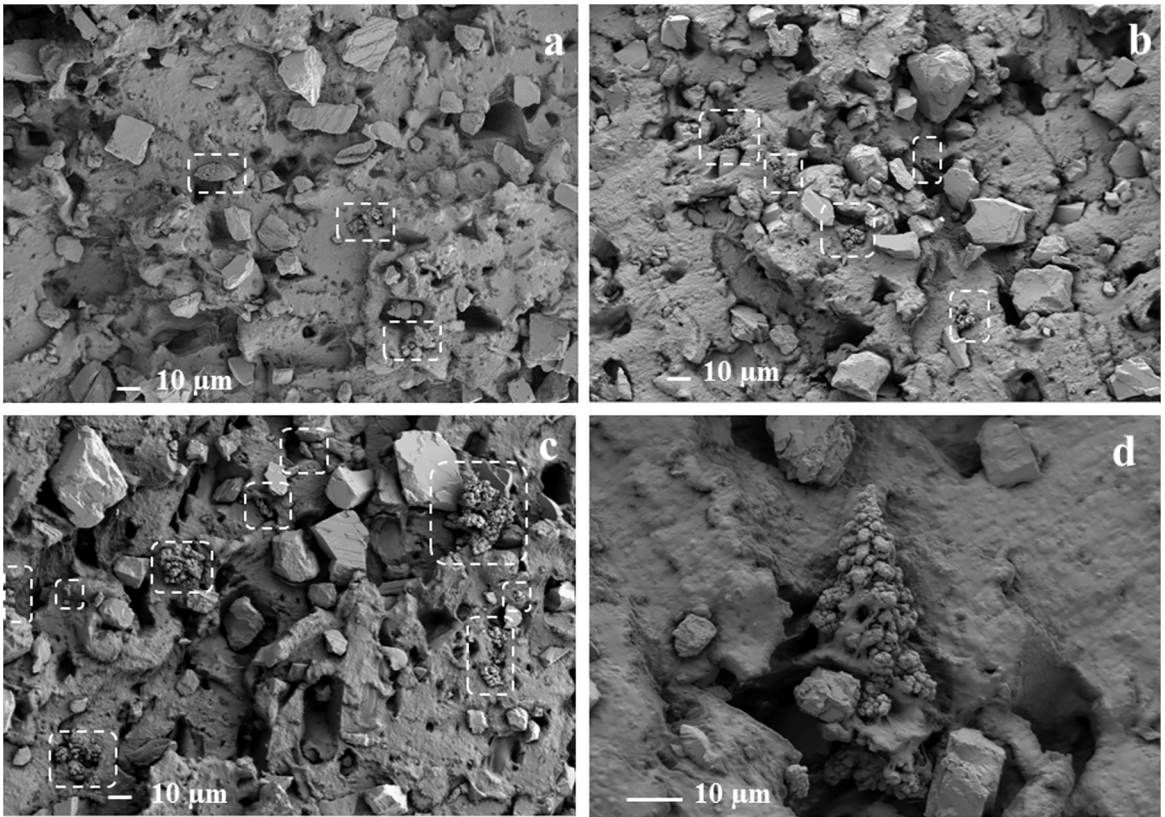
**Figure 3.** DSC curves of the compounds and the pure SEBS.**Figure 4.** SEM images of copper microparticles (CuMP)

5c show, respectively, the samples with 1%, 2% and 4% of CuMP and the Figure 5d shows a dendrite when incorporated into the compound. Comparing the size of CuMP in nature and when incorporated into the compounds, the smaller

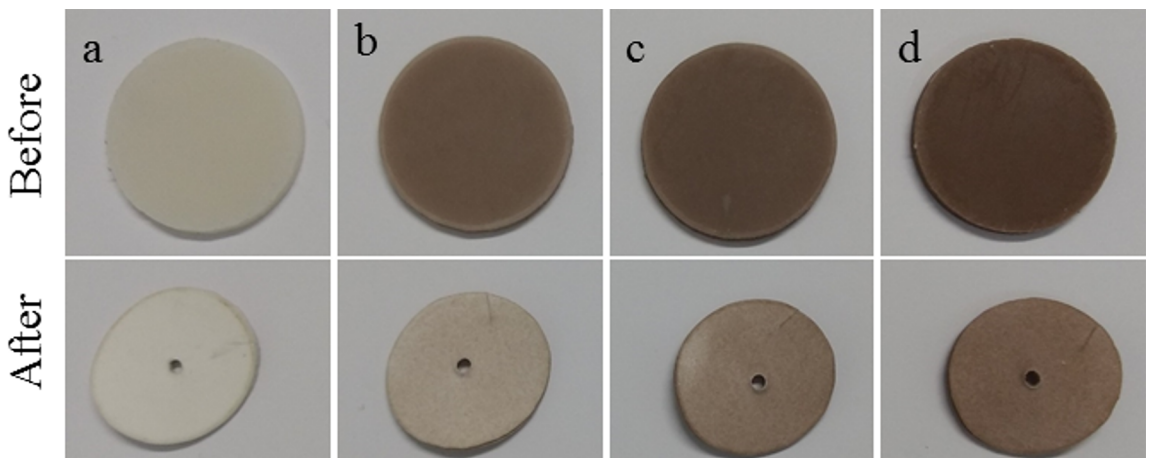
size of the particles within the compound suggests that the extrusion processing broke those particles. The comminution of CuMP is desirable because the size of particles is a relevant parameter in the release mechanisms of metal ions<sup>7</sup> that are a decisive factor in the antibacterial efficiency of the metal.

The microparticles are dispersed within the matrix of the analyzed samples. The co-rotating twin screw extruder used to produce the compounds has a configuration for SEBS/PP blends and the screw design is suitable to promote the dispersion of the fillers. The configuration of the equipment and the others parameters generate shear conditions appropriate to wetting, the breakage of the agglomerates and separation of particles. According to Palza<sup>3</sup>, in a study of polymers with metal nanoparticles, the high viscosity of the matrix at the melt state can improve the dispersion of the particles. Similar observation have been reported by Kasaliwal et al.<sup>26</sup>, who stated that a high melt viscosity of the matrix would help to apply higher shear stresses on agglomerates leading to their faster dispersion.

Previous studies indicate that, in the concentrations of SEBS and PP evaluated in this study, both polymers might have co-continuous structures in the matrix, forming a normally referred to as physically cross-linked interpenetrating network<sup>9,27</sup>. The results of the extraction tests with toluene indicate that the presence of copper did not interfere in the morphology of the SEBS and PP phases. All the compositions featured a similar percentage of solubilization of phase SEBS/oil, varying between 94.0% and 95.0%, indicating that almost all SEBS was accessible from the surface of the samples. The Figure 6 shows that the specimens maintained the original shape. According to Ohlsson et al.<sup>16</sup>, if all of the SEBS can be extracted, the SEBS phase is continuous and if the polypropylene remains in one piece with the original shape, the PP phase is continuous.



**Figure 5.** SEM images (a) Sample with 1% copper microparticles, (b) Sample with 2% copper microparticles, (c) Sample with 4% copper microparticles and (d) dendrite incorporated into the compound.

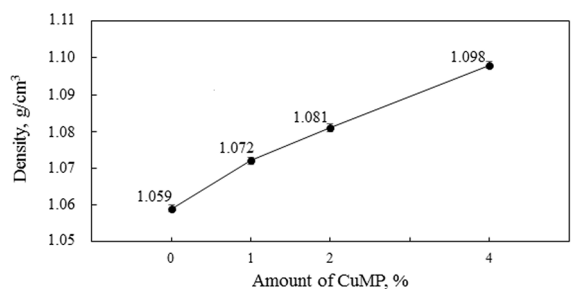


**Figure 6.** Images of the compounds before and after SEBS phase extraction. (a) 0% CuMP, (b) 1% CuMP, (c) 2% CuMP, (d) 4% CuMP

### 4.3 Physical and mechanical properties

The metal has a higher density than the other constituents of the formulation and the density increased by raising the copper content in the compounds, as observed in Figure 7.

The hardness and tensile properties are important to predict the mechanical performance of the compounds. Table 4 presents the results of these tests. A low reduction in the hardness of the compounds was observed with the presence of CuMP, but without a tendency. No significant



**Figure 7.** Density values of the compounds as a function of CuMP content

**Table 4.** Hardness and tensile properties of TPE compounds

Sample	Hardness (Shore A)	100% Modulus (MPa)	Elongation at Break (%)	Tensile Strength at Break (MPa)
0% CuMP	69.6 ± 0.7	1.86 ± 0.01	762 ± 41	9.06 ± 1.14
1% CuMP	68.1 ± 0.7	1.80 ± 0.01	781 ± 28	8.97 ± 0.96
2% CuMP	67.0 ± 0.7	1.90 ± 0.04	783 ± 26	9.10 ± 0.78
4% CuMP	67.8 ± 0.3	1.85 ± 0.03	791 ± 28	9.03 ± 1.04

variations in 100% modulus, elongation at break and tensile strength at break were observed with the addition of CuMP in compositions. The repeatability limit ( $r$ ) can be used to support or challenge that test results have been produced on the same material<sup>28</sup> and the degree of variation in these results can be attributed to the uncertainty of the test method.

#### 4.4 Antibacterial assays

The antibacterial activity of the compounds with the presence of copper microparticles was evaluated against the Gram-positive bacteria (*S. aureus*) and the Gram-negative bacteria (*E. coli*). As seen in Table 5, there were significant differences in the bacterial reduction value between loaded and non-loaded compounds. The CuMP containing compounds presented an antibacterial action in all concentrations tested.

The most accepted mode of action of copper as an antimicrobial mentions the modification of bacterial membrane permeability<sup>29</sup> and the generation of reactive oxygen species<sup>30</sup>, which can damage bacterial proteins, lipids and nucleic acids. Sun et al.<sup>12</sup> claim that, undoubtedly, killing bacteria process of copper started from the copper ions release. This confirms the one published by Delgado et al.<sup>31</sup>, which states that any material that can release Cu<sup>2+</sup> will present antimicrobial behavior. The water and oxygen retained with in the polymer matrix promotes the metal biocide action<sup>3,7,10</sup>. The process takes place by the interaction with the surface of the particles promoting a corrosion reaction that releases copper ions from the copper particles. The low polarity of the polypropylene favors the diffusion of water molecules through its interconnected amorphous parts defining a percolated network. As the PP and the SEBS present a little distinction in polarity<sup>1</sup>, a similar behavior was expected in the elastomeric phase of the CuMP compounds. A previous study

**Table 5.** Antibacterial activity of the compounds

Sample	<i>E. coli</i>		<i>S. aureus</i>	
	Reduction (%)	R	Reduction (%)	R
0% CuMP	No reduction	-	No reduction	-
1% CuMP	99.99	4.25	99.99	4.11
2% CuMP	99.99	4.40	99.99	4.07
4% CuMP	99.99	3.82	99.99	4.20

NOTE: R – logarithmic reduction of bacterial population. Effective if R ≥ 2.0.

developed by our research group, with similar composition based on SEBS/PP, had already shown the effectiveness of copper nanoparticles against *E. coli* and *S. aureus*<sup>13</sup>.

## 5. Conclusion

Based on these results, it can be inferred that the metallic additive produced no significant variation in the morphological, thermal, physical and mechanical properties of the compounds. This is a positive factor for the final application of these compounds in a wide variety of products. The melt-extruded blend proved to be a suitable process to produce compounds containing metal microparticles well dispersed. The processing conditions promoted a break of dendrites with a desirable decrease in the size of the particles. Ultimately, electrolytic copper microparticles presented antibacterial activity against the most common bacteria associated with infections (*E. coli* and *S. aureus*).

Further characterization is being developed to deepen understanding the effect of copper particles in compositions based on SEBS/PP. This information will improve the knowledge about the use of metallic particles in this type of TPE and its use in applications where antibacterial properties are a requirement.

## 6. Acknowledgements

The authors are grateful to Universidade Federal do Rio Grande do Sul (UFRGS) and Softer Brasil Compostos Termoplásticos LTDA. Funding. This work was supported by Financiadora de Estudos e Projetos (FINEP) [03.13.0280.00].

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